02-14-02   A

In the United States Patent and Trademark Office

Mailed 2001, February 10th

Box Patent Application
Assistant Commissioner for Patents
Washington, District of Columbia 20231

Sir:

Please file the following enclosed patent application papers:

Applicant #1, Name: __Haw-Minn Lu__

Applicant #2, Name: _____

Title: __Fanout Upgrade for a Scalable Switching Network__

☒ Specification, Claims, and Abstract: Nr. of Sheets __26__

☒ Declaration: Date Signed: _February 10, 2002_

☒ Drawings(s): Nr. of Sheets Enc.: Formal: __27__   Informal: _____

☒ Small Entity Declaration of Inventors(s)   ☐ SED of Non-Inventor / Assignee / Licensee

☐ Assignment enclosed with cover sheet and recordal fee; please record and return.

☒ Check for $ __412__ for:

   ☐ $ _____ for filing fee (not more than three independent claims and twenty total claims are presented).

   ☐ $ _____ additional if Assignment is enclosed for recordal.

☐ Disclosure Document Program reference letter.

☐ Pursuant to 35 U.S.C. §119(e)(i), applicant(s) claim priority of Provisional Patent Application Ser. Nr. _____,
   filed _____.

☒ Return Receipt Postcard Addressed to Applicant #1.

☐ Request Under MPEP § 707.07(j); The undersigned, a pro se applicant, respectfully request that if the Examiner
   finds patentable subject matter disclosed in this application, but feels that Applicant's present claims are not
   entirely suitable, the Examiner draft one or more allowable claims for applicant.

Very respectfully,

_____   _____
Applicant #1 Signature   Applicant # 2 Signature

__10733 Calston Way__   _____
Address (Send Correspondence Here)   Address

__San Diego, CA 92126__   _____

Express Mail Label #   EI924871620US   **: Date of Deposit 2001** __February 10th__

I hereby certify that this paper or fee is being deposited with the United States Postal Service using "Express Mail
Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to "Box Patent
Application, Assistant Commissioner for Patents, Washington, DC 20231."

Signed:
_____
                              Inventor

Patent Application Transmittal Letter